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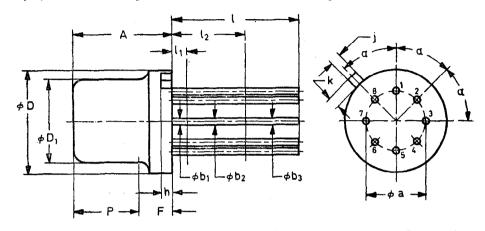


Ina.zn Standard

## DIMENSIONS OF SEMICONDUCTOR DEVICES DEVICE OUTLINE OD 25

## 1. Dimensions

Note — This drawing has been prepared in accordance with IS:5001 (Part I)-1969 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part I Semiconductor devices' and IS:5001 (Part II)-1973 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part II Integrated circuits'.



Reference	Millimetres			Degress	Notes
	N∙ in	Nom	Max	Nom	
A	6.10	_	6.60	_	
a	_	5.08*	-	_	1
b <sub>1</sub>	·		0.76	_	
b <sub>2</sub>	0.407	_	0.208	-	
<i>b</i> <sub>3</sub>	-	-	0.23	_	
D	8.64	_	9.39	-	
<i>D</i> <sub>1</sub>	7.75		8.51		
F	2.54		_		
h	0.15	_	1:0)		
j	0.712	0.787	0.863	_	
k	0.74		1.14	_	2
/1	_		1:27	_	
12	€.35	_		_	
1	7 7	12.7	15.2		
p	2.54	_			
α			_	45*	1

<sup>\*</sup>Means true geometrical position.



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Price Rs 5:00

## 15:5000 (OD 25)-1978

- Note 1 The cross section of each terminal at a distance  $I_1$  Max from the seating plane lies in a circle having a diameter of 0.99 mm centred at the true geometrical position defining the terminal axis at its point of exit.
  - Note 2 Measured from the actual diameter D of the device.
- Note 3 The minimum axial length from the seating plane beyond which the terminals may be bent at right angles in 3.8 mm.
  - Note 4 One or more terminals may be emitted but the terminal position retains its number.
- 2. Rules for Coding See 8.1 of IS: 5001 (Part I)-1969.
- 3. Equivalent Designation Code Followed by Other Countries and Organizations

Country or Organization	Designation Code		
India	OD 25		
IEC			
United Kingdom	SB8-1A/SB8-1B		
France	F42/F76 F65/F77		
USA	TO-76,77 78,79,80		
Germany	5C8		
Japan	TB-15A		